



IFW

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Confirmation No.:8919

Shunichi SEKI et al.

Allowed: May 5, 2005

Group Art Unit: 2826

Application No.: 10/686,634

Examiner: S. WILSON

Filed: October 17, 2003

Docket No.: 104741.01

For: METHOD OF FORMING THIN FILM PATTERNING SUBSTRATE INCLUDING
FORMATION OF BANKS

SECOND AMENDMENT UNDER 37 C.F.R. §312

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

A Notice of Allowance was mailed May 5, 2005. The Issue Fee has not yet been paid.

Please amend the above-identified application as follows:

Amendments to the Claims as reflected in the listing of claims; and

Remarks.